/ Revised record

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/ Electrical Characteristic Curve

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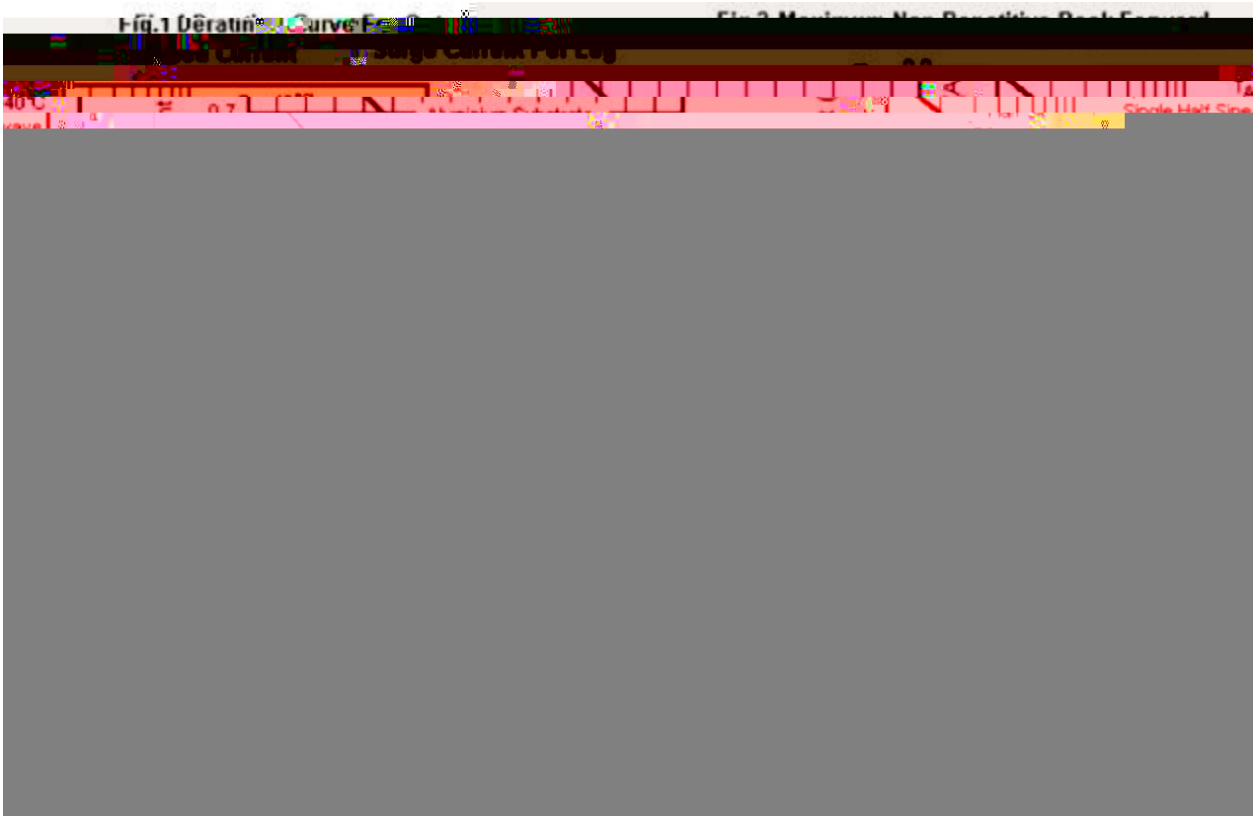

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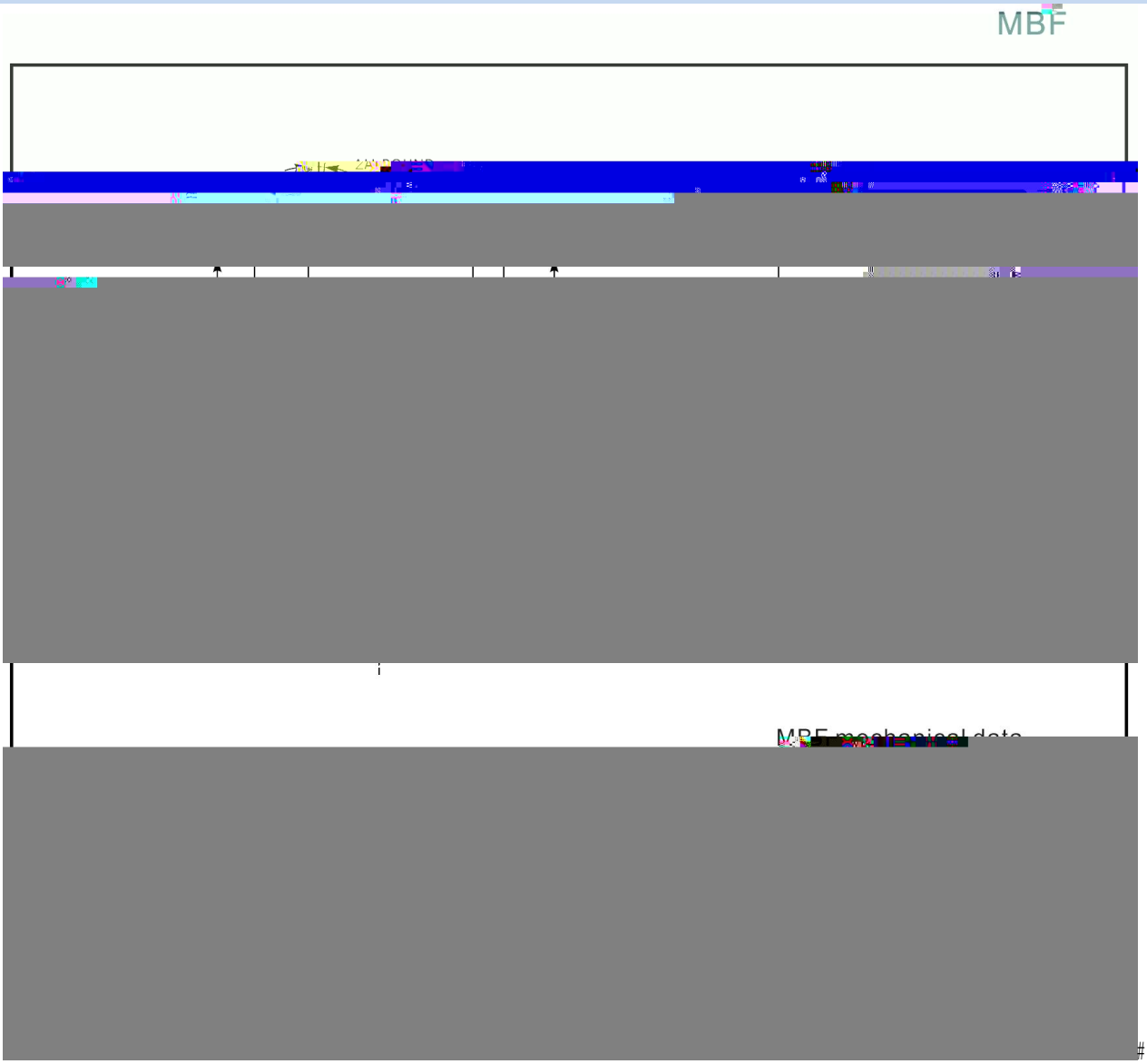
/ Package Dimensions



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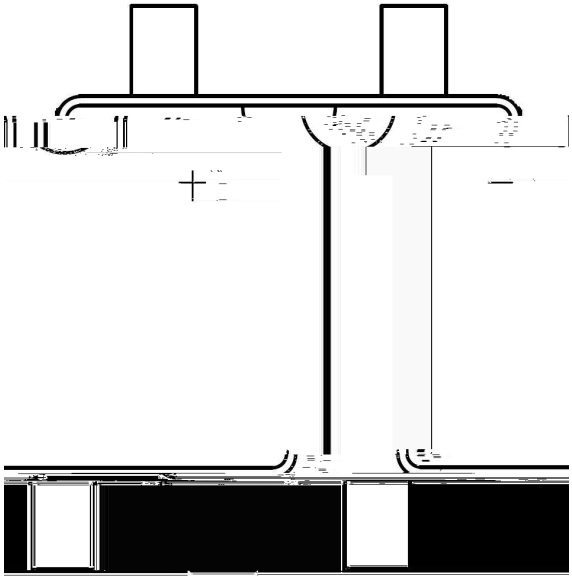
/ Marking Instructions



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( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)

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))G( )P(O(a(0 2b# # #)!>% * :+?;A,)G(c)P(℃E#U?4 ,O(ca(0 2!#
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R ')(℃-0 2!# # # # R! C33-?;A#8$ @,#'c)(℃-0 2!#
#

/ Resistance to Soldering Heat Test Conditions

#
m
'O(±G℃# #)(±)#0 2!## # # U 4$!,'O(±G℃# # U?4 ,)(±)#0 2#
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/ Packaging SPEC.

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